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September 12, 2001

To: Commissioner of Patents and Trademarks

Washington, D.C. 20231

Fr: George O. Saile, Reg. No. 19,572

20 McIntosh Drive

Poughkeepsie, N.Y. 12603

Prior art

Subject:

Serial No. 09/898,386 07/05/01

Shui-Hung Chen, Jian-Hsing Lee, Jiaw-Ren Shih, Ta-Lee Yu

DIODE FOR POWER PROTECTION

Grp. Art Unit: 2811

INFORMATION DISCLOSURE STATEMENT

The following Patents and/or Publications are submitted to comply with the duty of disclosure under CFR 1.97-1.99 and 37 CFR 1.56. Copies of each document is included herewith.

U.S. Patent 6,002,568 to Ker et al., "ESD Protection Scheme for Mixed-Voltage CMOS Integrated Circuits," discloses an ESD circuit using silicon controlled rectifier (SCR) devices. • TSMC-00-424

- U.S. Patent 5,898,205 to Lee, "Enhanced ESD Protection Circuitry," teaches an ESD protection circuit where conventional CMOS protection transistors are capacitively-coupled to improve performance.
- U.S. Patent 6,011,681 to Ker et al., "Whole-Chip ESD Protection for CMOS ICS Using Bi-Directional SCRS," discloses a circuit using bi-directional SCR devices to provide current discharge paths between separate power supplies.
- U.S. Patent 5,530,612 to Maloney, "Electrostatic Discharge Protection Circuits Using Biased and Terminated PNP Transistor Chains," teaches ESD protection circuits using biased diode strings and cantilevered diode strings.
- U.S. Patent 5,747,834 to Chen et al., "Adjustable Bipolar SCR Holding Voltage for ESD Protection Circuits in High Speed Bipolar/BiCMOS Circuits," discloses a bipolar SCR with an adjustable holding voltage wherein the device is entirely constructed in an n-well and uses a buried layer.

Sincerely,

Stephen B. Ackerman,

Reg. No. 37761